

Method for Heat Transfer and Device Therefor

TECHNICAL FIELD

5 A heat transfer device for transferring heat from a heat source to a heat-dissipating region is disclosed. The heat transfer device is particularly useful in thermal management of electronic components including micro-processors, liquid crystal displays (LCD), micro-electro-mechanical systems (MEMS), illuminating or radiating and like devices where the operation of such
10 components produces excess heat that needs to be transferred away, or as a heating element for rapid and controlled heater.

BACKGROUND ART

15 Many devices, due to their operation and throughput, produce heat which accumulates and adversely affect their continuous performance unless conducted away and dissipated. This is particular true for semiconductor devices such as processor devices (where the ever-increasing VLSI and processing speed and amount of data bits processed), liquid crystal displays
20 (LCD), illuminating devices such as light-emitting diodes (LED), etc. where various heat transfer devices are being employed for thermal management.

One of the significant advances made is in respect of heat pipes which may be employed in a flexible structure comprising multiple laminates such as

disclosed in U.S. Patent No. 6,446,706 (Thermal Corp.) as shown in FIGURES 1a and 1b (Prior art). The flexible heat pipe includes a sealed outer casing (26) comprising a polypropylene layer (28), a first metal foil layer (32) attached to the polypropylene layer (28) by a first adhesive layer (30), a
5 second metal foil layer (12) attached to the first metal foil layer 32 by a second adhesive layer 34, and a wick layer 24 which is formed using a flexible and porous material.

The heat pipe further includes a separation layer 18 which supports the
10 wick layer 24 such that the wick layer 24 stays in close contact with the outer casing 26 and allows vapour to flow in many directions in the casing. The separation layer 18 is realized as a mesh screen made of polypropylene. The wick layer 24 is made of a copper felt material. The copper felt comprises micro-fibres, each having a diameter of 20 micro inches and a length of 0.2
15 inches, and copper powder filled in the wick structure in an amount of 20 to 60% of the total volume of the wick structure.

Whilst the flexibility of the laminated layers allows it to be affixed over and conforms to a device to be cooled, contact surfaces between the various
20 laminate layers and the flexible heat pipe may be affected by the flexible material and configuration, thus affecting effective heat conduction.

There are several limitations associated with this prior art. Firstly it is difficult to make the heat pipe which has a complex inner structure. Since the

wick layer 24 is made of copper felt it is very difficult to maintain regular and strong contact between the inner surfaces of the outer casing and the wick layer 24. As such, forming of micro paths in the wick layer 24 is irregular, causing non-uniform capillary force that drives the flow. This creates high flow resistance which causes weak capillary force. Accordingly, when the coolant actively evaporates around a heat source, the flow of the vapour phase coolant may be cut off. Moreover, heat conductivity varies from point to point. Thus, reproducibility of the heat transfer device is poor. Another limitation is the thinness of the copper felt. Due to difficulty in manufacturing thin copper felt the total thinness of the heat pipe is limited by the thickness of the copper felt.

FIGURE 2 (Prior Art) illustrates a plate-type heat transfer device according to Korean Patent Laid-Open Publication Number 10-2004-18107. The heat transfer device comprises an upper plate 200, and a lower plate 100 disposed under the upper plate 200, having a gap between the upper plate 200 and the lower plate 100, in which the lower surface of the lower plate 100 corresponds to an evaporation part P1 and is in contact with a heat source. The heat transfer device further comprises wick plates 120 disposed so as to be in close contact with the upper surface of the lower plate 100 due to the surface tension of liquid coolant, and a spacer plate 110 for maintaining the distance between the lower plate 100 and the wick plate 120.

The liquid coolant circulates between the evaporation part P1 and a condensation part P2. That is, the liquid phase coolant continuously flows to the evaporation part P1 by means of capillary force generated between it and the lower plate, enters a vapour phase at the evaporation part P1, flows in a vapour phase toward the condensation part P2, and condenses at the condensation part P2. The spacer plate 110 serves to maintain the distance between the lower plate 100 and the wick plate 120 by using the surface tension generated between of them.

10 This second prior art has also limitations. Micro machining is needed to manufacture a thin and complex structure to be inserted between an upper plate and a lower plate, thus limiting mass production. Accordingly, the device's enclosure can be manufactured no thinner than several mm thick. The device's configuration is structured according to the liquid coolant flows in gaps formed between planar wicks provided in the wick plate 120, or gaps
15 formed between the wick plate 120 and the lower plate. Since the device incorporates micro structures, such as bridges, for connecting protrusions formed on the lower plate and the upper plate or connecting planar wicks, in order to form uniform gaps and to be mounted in the device' confined
20 enclosure, it is difficult to precisely machine such micro structures, as the micro structures are so complex and are several millimetres thick. Also, non-uniform gaps can result in drying out of the liquid phase coolant at the evaporation part, thereby causing fatal failure of the heat transfer device. In

particular, mass production of such micro structures is more difficult since the structure is so much complex and machining errors can occur.

FIGURE 3 is an illustration of third prior art of a flat sheet type heat transfer device disclosed in Korean Unexamined Patent Application No. 10-2004-91617. The heat transfer device shown in FIG. 3 comprises an upper metal plate 300, a lower metal plate 350, a pressuring support structure 310, and a plurality of thin plates 320 and 322, the pressuring pressure tension structure 310 and the thin plates 320 and 322 being interposed between the upper plate 300 and the lower plate 350. Each of the thin plates has through patterns that are parallel to each other, formed by a micromachining process. The pressuring pressure tension structure 310 is made of a porous material such as a mesh screen having through holes dense enough so that vapour, generated by the vaporization of coolant, occurring because the heat source is in contact with the lower surface of the lower plate 350, can move in a vertical direction.

The pressuring pressure tension structure 310 presses at least a portion of the parallel patterns of the thin plates 320 and 322 when assembled. Due to the pressure from the pressuring support plate 310, the parallel patterns of the thin plates 320 and 322 are in close contact with the upper surface of the lower plate 350, so that micro gaps, smaller than those of the patterns in an initial state, are formed. The micro gaps form fine coolant passages that

are of few micro meters which are difficult to realize by the processing method such as etching or machining.

The third prior art has following limitations. As shown in FIG. 4a and Fig 5 4b, the thin metal plate or mesh is not wettable or liquid-absorbing because of the nature of the material and its design. This can create repelling of coolant that can cause dry out phenomena to occur. Furthermore, maintaining fine passages are very difficult due to manufacturing difficulties, increasing the cost of manufacturing. Reducing the thickness of the metal plate or mesh is 10 critical in reducing the thickness of the device and the electronic device this is applied, but this process is difficult and incurs extra cost.

SUMMARY OF DISCLOSURE

15 It would therefore be ideal to have a heat transfer device that overcomes the above limitations and disadvantages, towards which it is now proposed, as a general embodiment, a heat transfer device comprising at least an aggregate of fibres or sheet of fibres with internal passages and holes capable of capillary transport of liquids from a heat source region to 20 heat dissipation region and *vice versa*; a supply of coolant fluid in sufficient amount absorbed or adsorbed by said fibres or sheet of fibres with internal passages and holes capable of capillary transport of liquids; pressure tension member (32) comprising a strong yet resilient structure placed within said confined space and exerting pressure on said aggregate of fibres or sheet of

fibres with internal passages and holes capable of capillary transport of liquids against said heat source region (30) and/or heat dissipation region, wherein a plurality of undulations are provided on said pressure tension member; and a casing enclosing hermetically the aforesaid in a confined space.

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In a first aspect of the invention, the undulations are provided at at least one of the heat source and heat dissipation regions. Alternatively, the undulations are provided in between the heat source and heat dissipation regions. The aforesaid undulations are preferably provided to accentuate the
10 exerted pressure.

In a specific embodiment of our invention, the undulations are provided as laterally extending protuberances. Preferably, the laterally extending protuberance is in H- and like-shaped protuberance.

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In another specific embodiment, the undulations may be preferably provided as protrusions extending in a direction perpendicular to inner surface of at least one of the enclosing members in which protrusions are provided in substantially hook-like shape, polygonal shape; including cylindrical, formed
20 by machining, casting, press-moulding or like processes or combination thereof. The protrusions' height are in less than 5 mm and are spaced equidistant in a range of about 0.2 to about 20 mm with a ratio of distance is at least 7:3 between protrusions to protrusion diameter.

In the second aspect of the invention, the pressure tension member is fabricated from metals, polymers, ceramics, silicon, organic or inorganic, stable, does not emit any form of gas or vapour at operation temperature ranges, does not peel off and non-reactive with the coolant, and it is
5 configured to maintain internal space. The internal space outlined by the pressure tension member may preferably form connected pathways forming 3-dimensional space for vapour conduction.

A specific embodiment of the pressure tension member is to provide for
10 an aggregate of fibres or sheet of fibres with internal passages and holes capable of capillary transport of liquids woven onto the pressure tension member or at least part thereof so that it is pressed against the fibres or sheet of fibres with internal passages and holes capable of capillary transport of liquids interwoven into a structural layer. Preferably, the pressure tension
15 member is configured such that its structure occupies minimal volume of not more than 30% so as to maximise vaporisation space of at least 70% within the confined space.

Yet another aspect of the invention concerns the coolant which is a
20 fluid having liquid-gas phase change of between -40°C to 200°C depending on to pressure exerted by at least one of the undulations of the pressure tension member. It may also be preferred to undergo phase change as it is conducted via capillary action from a heat source region to heat dissipation region and vice versa through the fibres or sheet of fibres with internal

passages and holes capable of capillary transport of liquids and/or 3-dimensional space formed by the connected pathways outlined by the pressure tension member.

5 Still another aspect of the invention concerns the fibres or sheet of fibres with internal passages and holes capable of capillary transport of liquids which are preferably fabricated from non-metallic, synthetic, inorganic and organic materials which are stable and non-reactive with other components of the device such as carbon nano-tube, with its average ratio of diameter to
10 length of a strand of a fibre is less than 0.05 and preferred to absorbent up to 90% of its volume.

A preferred embodiment of the fibres or sheet of fibres with internal passages and holes capable of capillary transport of liquids comprises tubular
15 structures having at least one hollow channel tubular passage in the order of micro- or nano-meter for intra-fibre capillary flow of coolant with diameter less than 1.0 mm or at least 10% of the fibre volume and fibre wall thickness less than 1.0 mm, with cross-sectional area of less than 0.79 mm^2 . The preferred aspect ratio is in the range of about 0.01 to 2.0, and the fibres have diameters
20 in the range of about $50 \mu\text{m}$ to 5.0 mm.

According to the following embodiment, the fibres are laid to converge towards the heat source region and diverge out to the heat dissipation region

wherein the fibres are interwoven to form a structural shape with each fibre strand spaced at less than 500 μm .

The casing, being yet another aspect of the invention, may preferably
5 comprises an upper enclosing member, lower enclosing member, in which
complementarily closes upon each other to enclose a confined space
thereinbetween in a fluid-proof manner; and a casing comprises a single
member having an upper enclosing part and a lower enclosing part hingedly
connected to each other and complementarily closes upon each other to
10 enclose a confined space thereinbetween in a fluid-proof manner. It is
preferably fabricated from metals, non-porous polymers, ceramics, crystals,
inorganic and organic in which has good thermal conduction, where the
internal surface does not in any form react with the internal materials such as
the coolant and or the pressure tension structure, while the casing's inner
15 surface area is increased by providing a plurality of fine channels formed by
wet etching, dry etching, machining, pressing or casting or combinations
thereof, and is resilient to increased internal vapour pressure.

The casing thus defines the device as being not more than 10.0 mm,
20 the casing wall is not more than 5.0 mm thick and the confined space
therewithin is less than 5.0 mm. Preferably, fibres are in contact with an inner
surface of a casing member for phase transition of the coolant and the fibres
are interposed between the pressure tension structure and inner surface of a
casing member. The fibres are positioned at above and below surfaces of the

pressure tension member at pressure-accentuated contact with at least one of the heat source region and heat dissipation region.

Our invention also discloses a method for transferring heat from a heat
5 source region to a heat dissipation region the device is also included; which comprises steps of providing a plurality of liquid absorbing and holding means capable of capillary convection of coolant fluid, wherein said convection means are aggregated in a form contacting a heat source region at one end and a heat dissipation region at another end; supplying coolant fluid in
10 sufficient amount, and absorbed and/or adsorbed by said fibres or sheet of fibres with internal passages and holes capable of capillary transport of liquids conduit means; imparting pressure on said fibres or sheet of fibres with internal passages and holes capable of capillary transport of liquids conduit means with pressure tensioning means, including providing undulating means
15 on said pressure tensioning means; and carrying out aforesaid means and steps in a hermetically confined space.

This method is preferably implemented in a heat transfer device, heat-generating device, including semiconductor device, in thermal contact with a
20 heat transfer device, chipset, circuit board or electronic component having a heat transfer device and/or appliance or machine.

LIST OF ACCOMPANYING DRAWINGS

The drawings listed below, with the accompanying detailed description that follows, may provide better and further understanding of our invention as
5 non-limiting and exemplary illustration of specific or preferred embodiments in which:

FIGURE 1 (Prior art) comprising FIGURE 1a and FIGURE 1b respectively illustrate a perspective view and schematic cross-sectional view
10 of US-6,446,706 wherein a heat pipe configuration disposed in flexible laminate layers;

FIGURE 2 (Prior art) shows a disassembled view of a plate or flat-type heat transfer device according to KR-10-2004-0018107 (Unexamined Publication);

15 FIGURE 3 (Prior art) illustrates a dissembled view of another plate or flat-type heat transfer device according to KR-10-2004-91617 (Laid-open Application);

FIGURE 4 (Prior art) comprising FIGURE 4a and FIGURE 4b respectively show comparative photographs of water adsorption and
20 absorption characteristics between layer 320 and layer 322 of the prior art device in FIG. 3;

FIGURE 5 comprising FIGURE 5a and FIGURE 5b respectively show the state of wettability of the non-metallic fibre sheet according to the present invention before and after lapse of one second;

FIGURE 6 comprising FIGURE 6a and FIGURE 6b show unassembled views of the first and second embodiments of our invention;

FIGURE 7 comprising FIGURE 7a and FIGURE 7b show cross sectional views of the first embodiment in FIG. 6a;

5 FIGURE 8 comprising FIGURE 8a and FIGURE 8b show respective unassembled views of the third and fourth embodiments of the present invention;

FIGURE 9 comprising FIGURES 9a, 9b, 9c and 9d, wherein FIG. 9a and 9b show cross sectional views of the third embodiment in FIG. 8a, and
10 wherein FIG. 9c and 9d show alternative embodiments of the protrusions;

FIGURE 10 illustrates perspective, detail and cross sectional view of a casing member formed with fine channels on its inner surface;

FIGURE 11 shows a perspective view with an open end of a tubular shape embodiment of the device according to the invention;

15 FIGURE 12 shows a cross sectional view of the tubular shape embodiment of FIG. 11 in an opened clam-shell configuration;

FIGURE 13 comprising FIGURE 13a and FIGURE 13b, illustrate end view of cross sections of two embodiments of the fibres or sheet of fibres with internal passages and holes capable of capillary transport of liquids used in
20 our invention, respectively showing duo tubular passage in a schematic drawing and quad tubular passages in a scanning electron microscope photograph;

FIGURE 14 comprising FIGURE 14a and FIGURE 14b, depict scanning electron microscope photographs of a fibre strand having a single tubular passage and an aggregate of fibres respectively.

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DETAILED DESCRIPTION OF PREFERRED EMBODIMENTS

The effectiveness of the wettable surface material used in our device may be demonstrated by showing in FIGURE 5a the dry non-metallic fibre sheet and the wettability state of the fibre sheet having been contacted with liquid after the lapse of about one second as shown in FIGURE 5b.

FIGURES 6a, 6b, 7a and 7b shall now be referred collectively. The typical general embodiment of the device according to our invention should comprise of the following 3 parts or components contained in a casing (50) which substantially defines the external dimensions of the device. The casing encloses hermetically the parts or components in a confined space therein.

The first part or component is an aggregate of fibres or sheet of fibres (60) with internal passages and holes capable of capillary transport of liquids. By "aggregate" we mean to include any suitable structure, form, shape or pattern of the fibres which may be aggregated, woven, spun or like physical treatment.

The fibres have properties for capillary convection of fluid, including coolant fluid. This capillary property of the fibre would be necessary for the convection of coolant fluid from a heat source region to a heat dissipation region and *vice versa*. It should be noted that the heat source or dissipation
 5 regions are typically opposing parts or ends of the device or casing, such as top (51) and bottom (52) surfaces of the casing (50), or a proximal end (54) and distal end (56) of the casing (50) so that a thermal gradient may exist between the heat source and the heat dissipation region.

10 The second component of our device is a supply of coolant fluid in sufficient amount which is absorbed or adsorbed by the fibres or sheet of fibres with internal passages and holes capable of capillary transport of liquids. This is achieved by means of cavities formed by the passages and holes within the fibres or sheet of fibres.

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The third component of our device is a pressure tension member (70) which is basically a strong yet resilient piece of structure. It is configured to maintain internal space of the casing to support it from collapsing or imploding due to external pressure or force or due to decrease in internal pressure due
 20 to excessive coolant vapourisation, etc.

The pressure tension member (70) is placed within the confined space of the casing (50) and is placed to exert pressure on the aggregate of fibres or sheet of fibres (60) with internal passages and holes capable of capillary

transport of liquids against said heat source region, for illustrative purposes is indicated as the proximal end of the casing (54) and/or heat dissipation region which is illustratively indicated as the distal end of the casing (56).

5 A unique feature of our pressure tension member (70) is that a plurality of undulations (80) is provided on the pressure tension member (70). The undulations (80) may preferably be provided at one or both of the heat source (54) and heat dissipation regions (56), bearing in mind that the regions may also be the opposing sides (51, 52) of the casing (50).

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The undulations may also be provided between the heat source region (74, 54) and the heat dissipating region (76, 56), such as that shown in FIGURE 6b as a row of equidistal protrusions (82) linking the two regions.

15 While the undulations are provided to essentially accentuate the pressure exerted on the fibres or sheet of fibres with internal passages and holes capable of capillary transport of liquids according to the undulation pattern (in contrast with the prior art's uniform pressure exerted), 2 specific types of undulations are further described hereinafter although many other
20 types may be derived from these two types.

The first type may described as laterally extending protuberances (84) which in FIGURE 6b are shown as a plurality lateral rib extensions from the sides of the pressure tension member (70) in a symmetrical arrangement.

Depending on the configuration of the heat transfer device the undulations distribution and the design of the pressure tension member (70) may be symmetrical or asymmetrical. The rib extensions may be seen as H-shaped protuberances (84) in the drawings. The rib extensions may also be provided
5 to extend from the ends (not shown) of the pressure tension member (70) in addition to its longitudinal sides which is shown with the protuberances (84). With this H-shaped protuberances (84) provided atop or below an aggregate or layer of fibres or sheet of fibres with internal passages and holes capable of capillary transport of liquids, an undulating pressure may be created on the
10 fibres following the undulations.

The second type of undulation may be described as protrusions (82) which are provided to extend from the top or bottom surface of the pressure tension member (70) in a perpendicular direction. For a casing having a
15 rectangular block or plate shape, the protrusions (82) may be provided as extending perpendicularly from the surface of the pressure tension member. For a tubular, polygonal or cylindrical casing where the components may be laid to follow the casing's inner surface curvature, the protrusions may be provided to extend in a direction that is perpendicular to the inner surface of
20 the casing.

A preferred embodiment of the protrusion (82) is a substantially hook-like shape as shown in the drawings. Other alternative shapes of the protrusion include polygonal shape, including cylindrical-like protrusions. All

these protrusions may preferably be formed by machining, casting, press-moulding or like processes or combination thereof. The hook-like protrusion, for example, may be fabricated by mould-pressing the appropriate part of the pressure tension member.

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The protrusion's height is preferably less than 5 mm and each of the protrusion are preferably placed equidistantly with each other in a range of about 0.2 to about 20 mm. The ratio of distance between protrusions to protrusion diameter is preferably 7:3.

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The pressure tension member (70) may preferably be fabricated from metals, polymers, ceramics, silicon, organic or inorganic materials, stable such that it does not emit any form of gas or vapour at given working temperature ranges or peel off and non-reactive with coolant.

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While all the drawings herein show the fibres or sheet of fibres with internal passages and holes capable of capillary transport of liquids being aggregated, woven or spun into a separate layer (60) which conforms to the pressure tension member (70) or casing so that at least part of the pressure
20 tension member (70) is pressed against the fibres or sheet of fibres with internal passages and holes capable of capillary transport of liquids which have been interwoven into a structural layer (60), as shown in various configurations FIGURES 6a – 9b, 11 and 12, it is also possible for the fibres to be woven onto the pressure tension member with a certain thickness of the

fibres overlaying the undulations, i.e. the protuberances (84) or protrusions (82), so that accentuated pressure may still be exerted on the fibres.

The pressure tension member (70) may preferably be configured such
5 that the total volume of its structure occupies minimal volume occupied in the casing and thus maximise vaporization space within the confined space of the casing. Accordingly, to maximise the pressure tensioning portions of the member, the rib extensions' layout may be maximised at regions where the pressure should be accentuated, such as the part of the pressure tension
10 member (74) or casing (54) over the heat source region or the corresponding parts over the heat dissipation region (76, 56). The pressure tension member's structure in between the regions (78) may preferably be minimised accordingly as shown in FIG. 6a and 6b. The space occupied by the pressure tension member should preferably be limited to not more than 30% of the total
15 volume of the confined space so that more void or empty space is available for the coolant to evaporate. The void may be advantageously formed as connected 3 dimensional passage ways for vapour conduction, condensation or coolant liquid's evaporation according to the heat regions.

20 An ideal coolant for our device would be a fluid having liquid-gas phase transition that is in the range of -40°C to 200°C . As with most fluids, the evaporation and condensation points would be subject to pressure. Our present device may provide 2 types of pressure, namely the accentuate pressure exerted by the undulations and, due to the 3-dimensional void

passage way network created by the configuration of undulations of the pressure tension member, vapour pressure arising from the amount of coolant evaporated in the confined space. Depending on the amount of the coolant in gas phase, the temperature of the void and nature of the passage way, i.e. whether a dead end or a connected passage, a vapour pressure gradient may arise between the heat source region and heat dissipation region. This might assist in providing a suitable range of temperature and pressure for effecting the desired phase transitions of the coolant for an efficient thermal conduction.

10

A complete cycle of the coolant's transition within the device may be described as follows. The coolant fluid at the heat source region (64) will absorb heat until sufficient entropic energy to change phase and evaporates. The coolant vapour spreads out through the void of the confined space in the casing as defined by the pressure tension member's configuration of protrusions (82) and protuberances (84). The further the vapour is from the heat source region, the lower is the temperature according to the thermal gradient.

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At the heat dissipation region, the temperature is the lowest where, with less entropy, the vapour tends to be denser resulting in increased vapour pressure, thus favouring the condensation of the coolant vapour back to liquid phase. The coolant liquid is adsorbed and absorbed by the fibres or sheet of

fibres with internal passages and holes and channelled via capillary action through the fibres back to the heat source region.

To achieve such tasks, the fibres or sheet of fibres with internal
 5 passages and holes capable of capillary transport of liquids are preferably
 fabricated from non-metallic, synthetic, inorganic and organic materials which
 are stable, does not emit any form of gas or vapour and peel off at given
 operating temperature ranges and non-reactive with the other components of
 the device such as the casing's inner surface and the pressure tension
 10 member. A particularly preferred material is carbon nano-tubes. With such
 materials, the tubular structure of the fibres may be industrially produced with
 one or more hollow tubular passage therein in the order of micro- or nano-
 metre for effective intra-fibre capillary flow of the coolant in liquid phase.

15 On the physical dimensions of the fibres or sheet of fibres with internal
 passages and holes capable of capillary transport of liquids, the average ratio
 of diameter to length of each strand of fibre is preferable less than 0.05. The
 ideal fibres or sheet of fibres with internal passages and holes would be one
 that can absorb or contain up to 90% of its volume. A preferred tubular
 20 passage diameter is less than 1.0 mm with a cross-sectional area of less than
 0.79 mm^2 . The tubular passage should ideally occupy at least 10% of the
 fibre volume and the fibre wall thickness should be less than 1.0 mm. Overall,
 the fibres or sheet of fibres with internal passages and holes capable of

capillary transport of liquids ideal diameters are in the range of about 50 μm to 5.0 mm.

The depth of the channels must be less than 500 micrometers and the cross sectional area must be less than 2.5mm^2 with the aspect ratio being less than 2.0 and greater than 0.01.

The fibres or sheet of fibres with internal passages and holes capable of capillary transport of liquids may be aggregated in any suitable way to form a structure that may range in density from loose to packed form. The aggregation may be achieved by a suitable treatment such as weaving, spinning, laying, aligning or simply grown and the like so that the strands of fibres are laid longitudinally from a heat source region to a heat dissipation region. For example, the fibres may be interwoven to form a structural shape with each fibre strand spaced at less than 500 μm . With such close proximity of the strands together, in addition to the intra-strand capillary action through the hollow tubular passage inside each fibre when the coolant fluid is absorbed or contained thereinto, the adsorption and containment of the coolant fluid on the external fibre strand surface may also be promote inter-fibre or inter-strand capillary action of closely placed adjacent fibres as a result of the adsorption or affinity of the fibres' surfaces for the coolant fluid.

It is preferred that the fibres are laid in a manner that converge towards the heat source region and diverge out to the heat dissipation region.

When our heat transfer device, which specific embodiment shown unassembled in FIG. 6a includes a single layer of fibres or sheet of fibres (60) with internal passages and holes capable of capillary transport of liquids, is
5 assembled as shown in cross sectional view in FIGURE 7a and FIGURE 7b, the pressure tension member (70) is placed atop the layer of fibres or sheet of fibres (60) with internal passages and holes capable of capillary transport of liquids with the lower surface of the protrusions (82) pressed against the fibres (60). The protrusions (82) are provided in addition to the lateral ribs or
10 protuberances (84). In particular, the protrusions are provided atop the lateral plane of the protuberances (84). The protrusions (82) therefore form the pressure points against the layer of fibres or sheet of fibres (60) with internal passages and holes capable of capillary transport of liquids.

15 The protrusions (82) may also be provided to project out from the bottom surface of the pressure tension member (70) as shown in cross sectional view in FIGURE 7a and 7b. With the sole layer of fibres or sheet of fibres (60) with internal passages and holes capable of capillary transport of liquids being placed at below the pressure tension member (70), the lower
20 protrusions (82) thus forms the pressure points against the fibres or sheet of fibres (60) with internal passages and holes capable of capillary transport of liquids.

The distribution of the protrusions (82) may also be provided in the most advantageous manner to heat conduction. In FIG. 6a, the protrusions (82) are shown provided in a concentrated manner in two regions, namely the heat source region (74) and the heat dissipation region (74). In this pattern of
 5 distribution, the fibres or sheet of fibres with internal passages and are pressed at the heat source region to maximise surface area contact and thus maximise conduction of heat from the heat source to the fibres to be conducted away. At the heat dissipation region, the fibres or sheet of fibres with internal passages and holes pressed against the protrusions (82) will
 10 maximise the surface area contact and maximise the conduction of heat from the fibres to the heat dissipation region.

Another example of protrusions (82) distribution is shown in FIG. 6b wherein the protrusions (82) are provided in a line linking the heat source
 15 region (74) and the heat dissipation region (76) so that the fibres or sheet of fibres with internal passages and in between or that linking the two regions are pressed against the pressure points of the pressure tension member for more surface area contact and thus more efficient conduction of heat between the two regions.

20

In another embodiment of our device, it is possible to provide multiple layers of fibres or sheet of fibres (60a, 60b) with internal passages and holes capable of capillary transport of liquids, i.e. one on each of the top and bottom surfaces of the pressure tension member (70) as shown collectively in

FIGURES 8a, 8b, 9a and 9b. The protrusions (82) provided above and below the pressure tension member (70) to each press against the upper (60a) and lower (60b). It is anticipated that such configuration would be advantageous for a heat transfer device which is configured with the heat source and heat
5 dissipation regions in the opposing sides of the casing (50a, 50b).

FIGURES 9c and 9d show different ways of making a pressure tension structure. The pressure tension structure is made from the same material as fibres or sheet of fibres (60) with internal passages and holes capable of
10 capillary transport of liquids used for transportation of liquids by either adding separate sheet of fibres atop one another or conforming by pressing fibres or sheet of fibres to the configuration or machining out from a thick sheet of fibres to configuration or combination of it.

15 With reference to the inner surfaces of the casing, it is preferable that the lower casing member's inner is provided with longitudinal ribs (55) as shown in FIGS 6a, 6b, 8a, 8b. Alternatively, a plurality of fine channels (57) is provided as shown in FIGURE 10. These fine channels (57) may be formed by wet etching, dry etching, machining, pressing or casting or combinations
20 thereof.

The longitudinal ribs (55) provide the pressure points in the same way as the pressure tension member's undulations while at the same time increases surface for heat conduction. The fine channels (57) will also

provide an increased surface area for heat conduction while at the same time provide for increased capillary action.

While it is generally considered that the casing (50) of our heat transfer
5 device would comprise an upper enclosing member (50a) and a lower enclosing member (50b) which complementarily closes upon each other to enclose a confined space therein between in a fluid-proof manner or hermetically, it is also possible to provide for a casing which comprises of a single member having an upper enclosing part (53a) and a lower enclosing
10 part (53b) hingedly connected to each other by a hinge portion (58) running lengthwise of the casing. The upper enclosing part (53a) and lower enclosing part (53b) and complementarily closes upon each other to enclose a confined space therein between in a fluid-proof manner as shown in FIGURE 11 in a closed tubular shape, and FIGURE 12 showing the tubular casing opened in
15 clam-shell and hinge configuration.

The casing may be fabricated from metals, non-porous polymers, ceramics, crystalline, inorganic or organic materials having good thermal conduction, or composites therefrom. Preferably, the chosen materials results
20 in a casing that is resilient to increase internal vapour pressure. The device's dimension is defined principally by the dimensions of the casing which for practical reasons should not be more than 10.0 mm. The casing wall should not be more than 5.0 mm thick whereas the confined space enclosed in the casing is less than 5.0 mm.

The fibres' or sheet of fibres' with internal passages and holes capable of capillary transport of liquids physical characteristics may be shown collectively in FIGURES 13a, 13b, 14a and 14b. FIG. 13a shows a scanning
5 electron microscope photograph of an aggregate of fibres or sheet of fibres with internal passages and holes while FIG. 13b shows a SEM photograph of an open end of a single strand of the fibres. The fibre is shown with a single hollow tubular passage. Fibres having multiple tubular passages are shown in FIGURES 14a and 14b wherein two and four tubular passages (62) are
10 illustrated in form of a schematic drawing and a SEM photograph respectively.

The aforesaid configuration of the device and method may be implemented in a device for heat transfer to be in thermal contact with another device or article, particularly for semiconductor devices, chipset, circuit board
15 or electronic components wherein excess heat produced has to be removed for optimal performance or where rapid and controlled heating is required.

Briefly, our heat transfer device works by implementing a method for transferring heat from a heat source region to a heat dissipation region on the
20 device in the following steps, which are:

- providing a plurality of fibres or sheet of fibres with internal passages and holes capable of capillary transport of liquids means capable of capillary convection of coolant fluid, wherein said convection means

are aggregated in a form contacting a heat source region at one end and a heat dissipation region at another end;

- supplying coolant fluid in sufficient amount, and absorbed and/or adsorbed and/or contained by said fibres or sheet of fibres with internal passages and holes conduit means;
- imparting pressure on said fibres or sheet of fibres with internal passages and conduit means with pressure tensioning means, including
 - providing undulating means on said pressure tensioning means;
- and
- carrying out aforesaid means and steps in a hermetically confined space.

Accordingly, it would be obvious to a skilled person that many of the above components may be adapted, modified or replaced with an equivalent component or part without departing from the aforesaid method or the principal features of our heat transfer device. These substitutes, alternatives or modifications are to be considered as falling within the scope and letter of the following claims.

CLAIMS

1. A heat transfer device comprising:
 - at least an aggregate of fibres or sheet of fibres (60) with internal
5 passages and holes capable of capillary transport of liquids from a heat
source region (54, 74) to heat dissipation region (56, 76) and *vice*
versa;
 - a supply of coolant fluid in sufficient amount absorbed or contained by
said fibres or sheet of fibres with internal passages and holes capable
10 of capillary transport of liquids;
 - pressure tension member (70) comprising a strong yet resilient
structure placed within said confined space and exerting pressure on
said aggregate of fibres or sheet of fibres with internal passages and
holes capable of capillary transport of liquids against said heat source
15 region (54, 74) and/or heat dissipation region (56, 76), wherein
 - a plurality of undulations (80) are provided on said pressure
tension member (70); and
 - a casing enclosing hermetically the aforesaid in a confined space.
- 20 2. A heat transfer device according to Claim 1 wherein the undulations
(80) are provided at at least one of the heat source (54, 74) and heat
dissipation regions (56, 76).

3. A heat transfer device according to Claim 1 wherein the undulations (80) are provided in between (78) the heat source (54, 74) and heat dissipation (56, 76) regions.

5

4. A heat transfer device according to any one of Claims 1 – 3 wherein the plurality of undulations (80) are provided to accentuate the exerted pressure.

10 5. A heat transfer device according to any one of Claims 1 – 4 wherein the undulations are laterally extending protuberances (84).

6. A heat transfer device according to Claim 5 wherein the laterally extending protuberance is in H- and like-shaped protuberance (84).

15

7. A heat transfer device according to any one of Claim 1 – 4 wherein the undulations are protrusions (82) extending in a direction perpendicular to inner surface of at least one of the enclosing members (50, 52).

20 8. A heat transfer device according to Claim 7 wherein the protrusions (82) are provided in substantially hook-like shape.

9. A heat transfer device according to Claim 7 wherein the protrusions (82) are provided in substantially polygonal shape, including cylindrical shapes.
- 5 10. A heat transfer device according to any one of Claims 7 – 9 wherein the protrusions (82) are formed by machining, casting, press-moulding or like processes or combination thereof.
11. A heat transfer device according to any one of Claims 7 – 10 wherein
10 the protrusions' height are less than 5 mm.
12. A heat transfer device according to Claim 11 wherein the protrusions are spaced equidistant in a range of about 0.2 to about 20 mm.
- 15 13. A heat transfer device according to any one of Claims 11 – 12 wherein the ratio of distance between protrusions to protrusion average diameter is 7:3.
14. A heat transfer device according to Claim 1 wherein the pressure
20 tension member is fabricated from any one or combination of the following:
- metals, polymers, ceramics, silicon, organic or inorganic materials which are non-fluid absorbing, stable and non-reactive with coolant.

15. A heat transfer device according to Claim 14 wherein the fabricated pressure tension member is configured to maintain internal space.

16. A heat transfer device according to any one of Claims 1 – 15 wherein
5 the aggregate of fibres or sheet of fibres with internal passages and holes capable of capillary transport of liquids are woven onto the pressure tension member.

17. A heat transfer device according to any one of Claims 1 – 16 wherein
10 at least part of the pressure tension member is pressed against the fibres or sheet of fibres with internal passages and holes capable of capillary transport of liquids which have been interwoven into a structural layer.

18. A heat transfer device according to any one of Claims 14 – 17 wherein
15 the pressure tension member is configured such that its structure occupies minimal volume so as to maximise vapourisation space within said confined space.

19. A heat transfer device according to Claim 18 wherein the pressure
20 tension member occupies not more than 30%.

20. A heat transfer device according to Claim 15 wherein the internal space outlined by the pressure tension member comprises connected pathways forming 3-dimensional space for vapour conduction.

21. A heat transfer device according to Claim 1 wherein the coolant is a fluid having liquid-gas phase change of between -40°C to 200°C , subject to pressure exerted.

5

22. A heat transfer device according to Claim 1 wherein the coolant undergoes phase change as it convects via capillary action from a heat source region (30) to heat dissipation region (40) and *vice versa* through the fibres or sheet of fibres with internal passages and holes capable of capillary
10 transport of liquids (20) and/or 3-dimensional space formed by the connected pathways outlined by the pressure tension member according to Claim 20.

23. A heat transfer device according to Claim 1 wherein the fibres or sheet of fibres with internal passages and holes capable of capillary transport of
15 liquids are fabricated from non-metallic, synthetic, inorganic and organic materials which are stable, does not emit any form of gas or vapour and does not peel off and non-reactive with other components of the device.

24. A heat transfer device according to Claim 22 wherein the average ratio
20 of diameter to length of a strand of fibre is < 0.05 .

25. A heat transfer device according to Claim 1 wherein the fibres or sheet of fibres with internal passages and holes capable of capillary transport of liquids are absorbent up to 90% of its volume.

26. A heat transfer device according to Claim 1 wherein the fibres or sheet of fibres with internal passages and holes capable of capillary transport of liquids comprises tubular structures having at least one hollow tubular
5 passage in the order of micro- or nano-meter for intra-fibre capillary flow of coolant.

27. A heat transfer device according to Claim 26 wherein the tubular passage average diameter is less than 1.0 mm with a cross-sectional area of
10 less than 0.79 mm^2 .

28. A heat transfer device according to Claim 26 wherein the tubular passage is at least 10% of the fibre volume and the fibre wall thickness is less than 1.0 mm.

15

29. A heat transfer device according to Claim 1 wherein the aspect ratio is in the range of about 0.01 to 2.0.

30. A heat transfer device according to Claim 1 wherein the fibres have
20 diameters in the range of about $50 \text{ }\mu\text{m}$ to 5.0 mm.

31. A heat transfer device according to Claim 1 wherein the fibres are laid to converge towards the heat source region and diverge out to the heat dissipation region.

32. A heat transfer device according to Claim 1 wherein the fibres are interwoven to form a structural shape with each fibre strand spaced at 500 μm .

5

33. A heat transfer device according to Claim 1 wherein the casing comprises

- at least an upper enclosing member (12a), and
- at least a lower enclosing member (12b),

10 complementarily closes upon each other to enclose a confined space thereinbetween in a fluid-proof manner;

34. A heat transfer device according to Claim 1 wherein the casing comprises a single member having an upper enclosing part and a lower
15 enclosing part hingedly connected to each other and complementarily closes upon each other to enclose a confined space thereinbetween in a fluid-proof manner.

35. A heat transfer device according to any one of Claims 33 and 34
20 wherein the casing is fabricated from any one of the following –

- metals, non-porous polymers, ceramics, crystals, inorganic and organic materials

which has good thermal conduction, or composites therefrom.

36. A heat transfer device according to any one of Claims 33 and 34 wherein the casing's inner surface area is increased by providing a plurality of fine channels.

5 37. A heat transfer device according to Claim 36 wherein the plurality of fine channels are formed by wet etching, dry etching, machining, pressing or casting or combinations thereof.

38. A heat transfer device according to any one of Claims 33 and 34
10 wherein the casing is resilient to increased internal vapour pressure.

39. A heat transfer device according to any one of Claims 33 and 34 wherein the casing defining the device is not more than 10.0 mm, the casing wall not more than 5.0 mm thick and the confined space therewithin is less
15 than 5.0 mm.

40. A heat transfer device according to any one of Claims 32 – 34 wherein the fibres are in contact with at least part of an inner surface of a casing member where heat is exchanged for phase transition of the coolant.

20

41. A heat transfer device according to Claim 40 wherein the fibres are interposed between at least part of the pressure tension structure and at least part of an inner surface of a casing member where heat is exchanged.

42. A heat transfer device according to Claim 40 wherein the fibres are positioned at above and below surfaces of the pressure tension member at pressure-accentuated contact with at least one of the heat source region and heat dissipation region.

5

43. A heat transfer device according to Claim 1 wherein the aggregate of fibres or sheet of fibres (60) with internal passages and holes capable of capillary transport of liquids are woven or fabricated integrally as or in the shape of a pressure tension member (70).

10

44. A method for transferring heat from a heat source region to a heat dissipation region of a heat transfer device comprising the steps of:

- providing a plurality of fibres or sheet of fibres with internal passages and holes capable of capillary transport of liquids convecting means
15 capable of capillary convection of coolant fluid, wherein said convecting means are aggregated in a form contacting a heat source region at one end and a heat dissipation region at another end;
- supplying coolant fluid in sufficient amount, and absorbed and/or contained by said fibres or sheet of fibres with internal passages and
20 holes capable of capillary transport of liquids conduit means;
- imparting pressure on said fibres or sheet of fibres with internal passages and holes capable of capillary transport of liquids conduit means with pressure tensioning means, including

- providing undulating means on said pressure tensioning means;
and
- carrying out aforesaid means and steps in a hermetically confined space.

5

45. A method for transferring heat according to Claim 44 implemented in a heat transfer device.

46. A method for transferring heat according to Claim 44 implemented in a
10 heat transfer device according to any one of Claims 1 – 43.

47. A heat-generating device, including a semiconductor device, in thermal contact with a heat transfer device according to any one of Claims 1 – 43,
operating optionally with another heat dissipating device such as a cooling
15 fan.

48. A chipset, circuit board or electronic component having a heat transfer device according to any one of Claims 1 – 43.

20 49. An appliance or machine including a heat transfer device according to any one of Claims 1 – 43.

50. A heating device for rapid and controlled heating such as in hair iron according to any one of Claim 1 – 43.